



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	14.22	14.99	0.560	0.590
B	9.77	10.54	0.385	0.415
C	4.06	4.82	0.160	0.190
D	0.58	0.94	0.023	0.037
E	1.14	1.40	0.045	0.055
F	14.43	14.81	0.568	0.583
G	1.27	BSC	0.050	BSC
J	0.38	0.56	0.015	0.022
K	18.49	18.87	0.728	0.743
L	8.18	8.56	0.322	0.337
M	2.57	2.95	0.101	0.116
N	2.28	2.91	0.090	0.115
Q	3.70	3.95	0.146	0.156
S	3.81	5.08	0.150	0.200
U	11.68	12.07	0.460	0.475
W	3°		3°	

NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- DIMENSION D DOES NOT INCLUDE INTERCONNECT BAR (DAM BAR) PROTRUSION. DIMENSION D INCLUDING PROTRUSION SHALL NOT EXCEED 10.92(0.043) MAXIMUM.
- LEADS MAINTAIN A RIGHT ANGLE WITH RESPECT TO THE PACKAGE BODY TO WITHIN  $\pm .020$ ".
- 821H-01 OBSOLETE. NEW STANDARD IS 821H-02

CASE NO.	821H-02
STATUS	ON SEMICONDUCTOR STANDARD
NEW STD	
USED ON	



ISSUE	REVISION	COORD/ DATE
0	INITIAL RELEASE REQ BY T. GRINTER	FB 04 AUG 00
A	CORRECTED DIM A INCHES WERE REVERSED. REQ BY F. PADILLA	FB 18 OCT 00